



模块 1

活动：使用 CCS 在 LaunchPad 上进行编程



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问题1 开始调试一段程序

准备一段程序用来进行调试

问题2 EnergyTrace

尝试使用CCS中的EnergyTrace功能。EnergyTrace有什么作用？在嵌入式系统设计中EnergyTrace的意义何在？

问题3 TI-RTOS

尝试使用TI-RTOS。找一个基于TI-RTOS的例程，在LaunchPad上运行。

问题4 TExaSdisplay逻辑分析仪

体验TExaSdisplay逻辑分析仪。逻辑分析仪在调试程序是有什么作用？

问题5 驱动程序

当使用一个开发板时，为什么必须安装相应的驱动？

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